



SMD Series



SMD nickel sensor

For automated assembly on PCBs









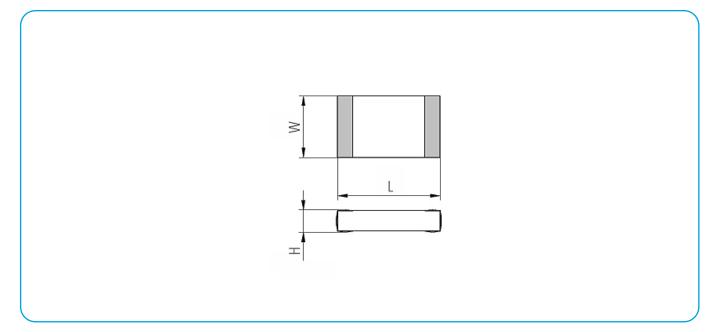


Benefits & characteristics

- Vibration and temperature shock resistant
- Simple linearization
- Excellent long-term stability
- Low self-heating

- Reflow solderable
- Available as Tape&Reel
- Customer-specific sensor available upon request

Illustration 1)



¹⁾ for actual size see dimensions in order information

Technical Data

Operating temperature range:











Nominal resistance:* 891 Ω at 0 °C Characteristics curve:* 6370 ppm/K (Nickel NJ) Long-term stability: < 0.1 % at 1000 h at maximal operating temperature Tolerance class:* iST reference (dependent on temperature range) Customer specific K Connection:* 2P (Contacts tin-coated (100% Sn), reflow solderable) Bondable contacts without bumps available on request Solderability: 235 °C \leq 8 s (DIN IEC 68 2-20, Ta Meth. 1) Resistance to soldering heat: ²⁾ 260 °C 10 s (DIN IEC 68 2-20, Ta Meth. 1A) 2)The soldering process can influence accuracy Recommended applied current: ³⁾ 0.3 mA at 891 Ω 3) Self-heating must be considered Other alternatives:* Substrate thickness	5	operating temperature range.	00 0 00 130 0		
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Other alternatives:* Substrate thickness		3) Self-heating must be considered			
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< 100 pcs in bags

> 100 pcs taped on reel (sensor side up or sensor side down)

-60 °C to +150 °C

Packaging:

^{*} Customer-specific alternatives available















Order Information

Nominal Size Dimensions
Resistance (L x W x H in mm)

Order code

Product name (secondary

reference)

Wire Special length

length in mm

2P (contacts tin-coated (100% Sn), LMP lead-free (reflow solderable))

Packed in bags (< 100 pcs)

6370 ppm/K (Nickel NJ)

891 Ω 0805 2 x 1.2 x 0.4

Class K

Class K

Class K

Class*

103258

NJ891.0805.2P.K

Taped on reel - sensor side up or sensor side down (> 100 pcs)

6370 ppm/K (Nickel NJ)

891 Ω 0805 2 x 1.2 x 0.4
 891 Ω 0805 2 x 1.2 x 0.4

103252 On request NJ891.0805.2P.K.S

Sensor side up

NJ891.0805.2P.K.S Sensor side down

Additional Documents

Application Note Document name: ATN_E



Order Information

SMD nickel Sensor - Secondary reference





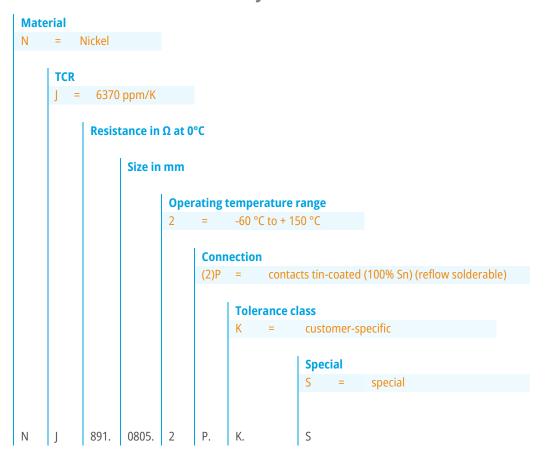














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All mechanical dimensions are valid at 25 °C ambient temperature, if not differently indicated • All data except the mechanical dimensions only have information purposes and are not to be understood as assured characteristics • Technical changes or product specifications without previous announcement reserved • The information on this data sheet was examined carefully and will be accepted as correct; No liability in case of mistakes • Load with extreme values during a longer period can affect the reliability • The material contained herein may not be reproduced, adapted, merged, translated, stored, or used without the prior written consent of the copyright owner • All rights reserved.

